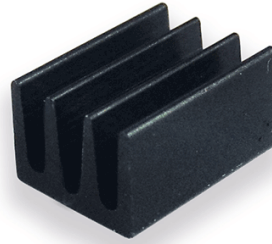


## Product features PR

### 7/8,5/SE

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Semiconductor casing:	DIL ; DIL 6/8 polig
Semiconductor mounted by:	Bonding
Heat sink mounted by:	Adhesive Bounding
Finish	Black Anodised
Material	AlMgSi0,5
Width [mm]:	6.4
Height [mm]:	4.8
Length [mm]:	8.5
Standardlänge [mm]:	8.5
Min. thermal resistance [K/W]:	80.0



## Further information

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- Extruded heatsinks especially for IC's in DUAL IN LINE case. -  
Mounting by single component thermal conductive adhesive  
type WK 709. - Standard length: 8,5 mm for 6/8 pins - Other  
lengths and machining on request.

